

NMOS SINGLE-CHIP 4-BIT **MICROCOMPUTER**

MB88400 **SERIES**

NMOS SINGLE-CHIP 4-BIT MICROCOMPUTER

The Fujitsu MB88400H series NMOS single-chip 4-bit microcomputer family is a upgrade version of the conventional MB8840 series.

The currently available member of the MB88400 series is the MB88401 only. MB88401H contain a 4K by 8-bit mask ROM (program memory), a 192 by 4-bit static RAM (data memory), a 36 I/O lines (including a serial port), an 8-bit timer/ counter, and a clock generator.

This device fabricated by the NMOS process, packaged in a 42-pin plastic standard, shrink DIP, or 48-pin plastic flat package. They operate with a single +5 V power supply and a 2 MHz clock without a prescaler (or 4.19 MHz clock with prescaler) over the temperature range of -30 °C to +70 °C.

For user's development of the MB88400 series based system, Fujitsu provides the MB88400/500 cross-assembler and host-emulator which run on the CP/M-86 or PC-DOS machines (cross-assembler also run on the Intellec series III MDS), and the MB2115 series evaluation board system, and the MB88408U piggyback EPROM evaluation devices which have external 4K x 8-bit EPROM (MBM2732A). These development tools enables users to minimize their development time and cost.

TM342-A871: January 1987





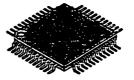
42-PIN PLASTIC STANDARD DIP (DIP-42P-M01)

HB88401-PSH



42-PIN PLASTIC SHRINK DIP (DIP-42P-M02)

MB88401-PF



48-PIN PLASTIC FLAT PACK (FPT-48P-M02)

MB88408U-C





42-PIN CERAMIC MODULE (MDP-42C-P04)

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.



FEATURES

- CMOS Single-chip 4-bit Microcomputer
- Program Memory:
 - o 4K x 8-bit mask ROM
- Data Memory:
 - o 192 x 4-bit static RAM
- 36 I/O Lines:
 - o K-Port: 4-bit parallel input only port o P-Port: 4-bit parallel output only port o O-Port: 8-bit parallel output only port
 - o R-Port: Three 4-bit and a 3-bit parallel or 15 individual input/output ports o C-Port: Serial I/O, interrupt input, timer/counter input, and timing output
- Three Selectable Output Port Types for O-, P-, and R-Ports with Mask Option:
 - o Standard open-drain
 - o Standard pull-up
 - o High-current open-drain
- Two Selectable K-Port Input Level with Mask Option:
 - o Standard threshold level
 - o High threshold level
- On-chip Mask-programmable PLA (Programmable Logic Array) for Data Conversion at O-Port
- 8-bit Programmable Timer/Counter with Two Clock Modes:
 - o Internal clock (Timer)
 - o External clock (Counter)
- Software Selectable Serial I/O with 4-/8-bit Serial Buffer/Three Clock Modes:
 - o Internal clock
 - o External clock
 - o Software clock
- On-chip Clock Generator with 2 Mask Options:
 - o External crystal/ceramic resonator or external clock drive
 - o External RC-network or external clock drive
- Mask-option Divide-by-two Clock Prescaler for Expanding Clock Range
- Single Level Four Prior Source Maskable Interrupt:
 - o External
 - o Clock
 - o Timer/counter overflow
 - o Serial buffer full/empty
- 8-nesting Levels for Subroutine Call
- Instruction Set:
 - o Number of instructions : 75
 - o Instruction length/cycle: 1 byte/1 cycle (82%), 2 bytes/2 cycles (17%), and
 - 2 byte/3 cycle (1%)
 - o Execution time : 2.86µs min. using 4.19MHz clock with prescaler

MB88400 SERIES

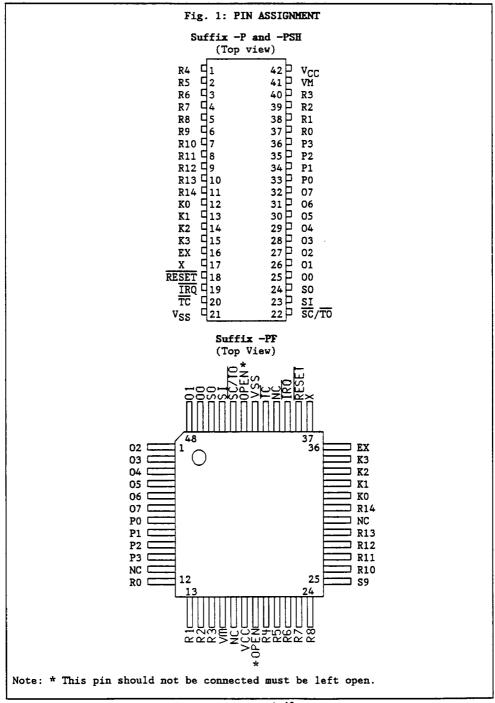


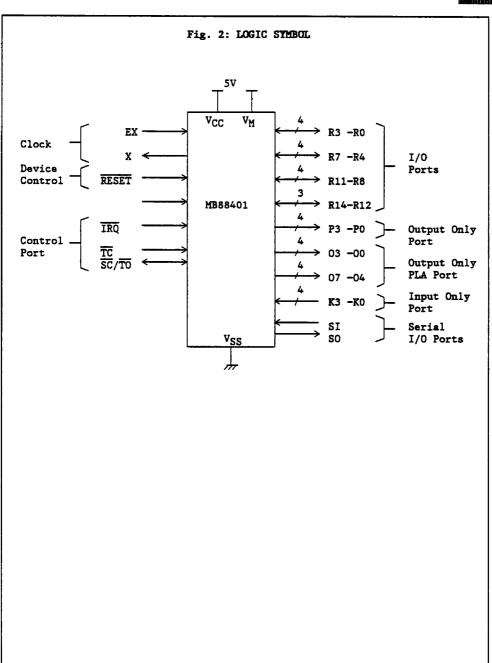
FEATURES (Continued)

- On-chip Power-on Reset Circuit
- Watch-dog Timer Function with Mask Option
- Power Dissipation: o 75mA
- Power Supply:
 - o Main power supply (VCC) : 4.5V to 5.5V
 - o Memory back up supply (VM): o Active mode: 4.5V to 5.5V o Standby mode: 3.0V to 5.5V
- Operation Temperature Range:
 - o $T_A = -30$ °C to +70 °C
- · Silicon Gate NMOS Technology
- · Three Package Types:
 - o 42-pin plastic standard DIP: Suffix -P o 42-pin plastic shrink DIP: Suffix -PSH o 48-pin plastic flat package: Suffix -PF
- Powerful Development Support:
 - o CP/M-86, PC-DOS, or Intellec series III MDS cross assemblers (SM07415-A012/SMXXXXX-XXXX/SM0525-A010)
 - CP/M-86 or PC-DOS host-emulator software for monitoring evaluation board and symbolic debugging (SM07415-G022/SMXXXX-XXXX)
 - o MB2115 evaluation board for software debugging
 - o MB88408U NMOS piggyback EPROM evaluation

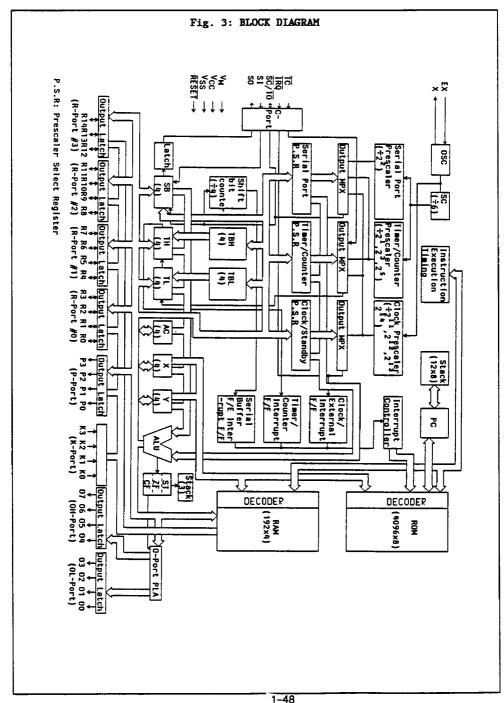














PIN DESCRIPTION

Fig. 1 and Table 1 show the pin assignment and pin description of the MB88400 series.

Table 1: PIN DESCRIPTION

Symbol	Pin No.	Туре	Name & Function
Power S	upply		
v _{CC}	42 (18)	-	+5V DC main power supply pin.
V _M	41 (16)	-	Data memory backup power supply.
V _{SS}	21 (42)	-	Ground pin.
Clock			
EX	16 (36)	I	Oscillator Input: Input to the inverting amplifier that forms the on-chip oscillator. An external crystal/ceramic resonator or RC-network is connected between the EX and X pins. Either of these two oscillation types can be selected using mask option. When an external oscillator is used, the EX pin receives the external oscillator signal.
			This pin is a non-hysteresis input when the crystal/ceramic oscillator is selected, and a hysteresis input when the RC-network oscillator is selected.
X	17 (37)	0	Oscillator Output: Output of the inverting amplifier that forms the on-chip oscillator, and input to the internal clock generator. An external crystal/ceramic resonator or RC-network is connected between the EX and X pins. Either of these two oscillator types can be selected using mask option. When an external oscillator is used, the X pin should be left open.
Device	Control		
RESET	18 (38)	Ī	Reset: This pin function as an external reset input or power-on reset output. External reset input: A reset input to the internal reset circuit. A low level on the RESET pin forcedely stops the MCU's operation, and initializes its internal state. After the RESET pin returns high, the MCU restarts execution of program from address #0. The RESET pulse must be low for at least two instruction cycles while the oscillator is stably running after power-on. This pin is a hysteresis input with an internal pullup resistor. An external capacitor from the RESET pin to the VSS pin (and the internal pull-up resistor), whose time constant should be greater than the reset time required (12 clock periods) composes the external reset circuit.



Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Туре	Name & Function
• Device	Control (Conti	nued)
RESET	18 (38)	1/0	Power on reset output: A reset output from the on-chip reset control circuit. Normally this output is high during the active operation except the reset mode. The rising of the VCC voltage after power on outputs a low level on the RESET pin, and them automatically returns high 2 ^{1*} clock periods after the oscillator starts by power on. This pin is a hysteresis input with an internal pullup resistor.
• C-Port			
ĪRQ	19 (39)	I	Interrupt Request: A maskable external interrupt input to the on-chip interrupt control circuit. The falling edge of the IRQ pulse sets the external interrupt request flag (IRF) in the interrupt flag register regardless of enabling or disabling the external interrupt. If the external interrupt is enabled in advance by EN instruction, the interrupt sequence starts at once. Otherwise, the IRF flag is internally held as an interrupt source. Also, the IRQ pin state (logical level), which is reflected in the external interrupt input flag (IF) regardless of enabling or disabling the external interrupt, is testable using TSTI instruction. (When IRQ = L, IF = 1; otherwise IF = 0.)
			resistor.
TC	20 (40)	I	Timer/Counter: An external count clock input to the onchip 8-bit timer/counter. The falling edge of the TC pulse increments the timer/counter by one bit, when the external count clock (counter) mode is enabled by EN instruction programming the timer/counter prescaler select register using OUT instruction (with Y = B). Also, the TC pin state (logical level), which is reflected in the timer/counter input flag (TCIF) in the timer/counter prescaler select register regardless of enabling or disabling the external count clock (counter mode, is testable by reading the prescaler select register using IN instruction (with Y = B). (When TC = L, TCIF = 1; otherwise TCIF = 0.) This pin is inactive as a count clock input when the external count clock mode is not selected or the timer/counter is disabled by DIS instruction or reset. This pin is a hysteresis input with an internal pullup resistor.



Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Туре	Name & Function
• C-Port	(Continue	d)	
SC/TO	22 (44)	I/0	Shift Clock/Timing Output: One of the shift clock input (SC), shift clock output (SC), or synchronous timing output (TO) is enabled using EN instruction.
		I	SC: 1) Shift clock input to the on-chip serial port: When the external shift clock mode is enabled for the serial port, the falling edge of the external SC clock shifts the contents of the internal serial buffer one bit right (from MSB to LSB). This input is inactive when the external clock mode is not selected or the serial port disabled by DIS instruction or reset. This pin is a hysteresis input.
			2) Shift clock output from the on-chip serial port: When the internal shift clock mode is enabled, the internal shift clock shifts the contents of the serial buffer one bit right. In this mode, the internal timing signal selected is output onto the SC pin for synchronization.
		0	TO: Synchronous timing output: When the timing output is enabled, the internal timing signal (which is generated by the on-chip state counter outputs, \$1 and \$2) is output onto the TO pin. By DIS instruction or reset, the TO pin is disabled and stops issuing the timing output. This pin is a hysteresis input with an internal pullup
			resistor
SI	23 (45)	I	Serial Data Input: Data input to the on-chip serial port. The rising edge of the external (SC) or internal shifts the data bit on the SI pin into the MSB of the serial buffer register when the serial port is enabled by EN instruction. Also, the SI pin state (logical level) is reflected in the serial data input flag (SIF) in the serial port prescaler select register regardless of enabling or disabling the serial port. Therefore, the SI pin can be sensed by reading the prescaler register using IN instruction (with Y = A).
so	24 (46)	0	Serial Data Output: Data output with latch of the on- chip serial port. The falling edge of the external (SC) or internal shift clock shifts the LSB data of the serial buffer register to the serial port output latch, regardless of enabling or disabling to serial port. The content of the output latch directly appears on the SO pin. This pin is a CMOS pullup output, and is set high by reset.



Table 1: PIN DESCRIPTION (Continued)

Symbol Symbol	Pin No.	Type	Name & Function
• I/O Por	ts		
K3-K0	15-12 (35-32)	Ĭ	K-Port: A 4-bit parallel non-latched input only port. KO is LSB. 4-bit data on K-Port is input into the accumulator by INK instruction.
			These pins are internally pullup.
P3-P0	36-33 (10- 7)	0	P-Port: A 4-bit parallel latched output only port. Po is LSB. 4-bit data in the accumulator is output to P-Port by OUTP instruction.
			Refer to Table 4 User mask options for available making option.
03-00,	28-25 (2,1,48, 47) 32-39 (6-3)	0	O-Port: An 8-bit parallel latched output only port with the on-chip mask programmable PLA (Programmable Logic Array) for output data conversion. Depending on user's PLA pattern, this port functions as a dual 4-bit parallel output or an 8-bit parallel PLA output.
			Dual 4-bit parallel output: By OUTO instruction, 4-bit data in the accumulator is output, without conversion, onto the lower nibble (03-00) or upper nibble (07-04) of 0-Port, depending on whether the carry flag (CF) is "0" or "1".
			8-bit parallel PLA output: By OUTO instruction, 4-bit data in the accumulator and the carry flag (CF) bit are converted into 8-bit data through the PLA array, and the 8-bit data is output to 0-Port. Depending on user's PLA pattern, 32 kinds of 8-bit data conversions are possible. For example, it can be encoded into 8-segment data for LED display.
			Refer to Table 4 User mask options for available making option.
R3 -R0, R7 -R4, R11-R8,	40-37, (15-12) 4-1, (23-20) 8-5,	1/0	R-Port: This port functions as three 4-bit parallel input and one 3-bit parallel input (non-latched)/output (latched) ports, or 15 individual input (non-latched)/output (latched) lines, depending on instructions.
R14-R12	(27-24) 11- 9 (31,29, 28)		Parallel I/O: Each 4-bit and 3-bit port is named R-Port #0 (R3-R0), R-Port #1 (R7-R4), R-Port #2 (R11-R8), and R-Port #3 (R14-R12), and is indirectly addressed by the Y-register (Port #). 4-bit data in the accumulator is output to an addressed port of R-Ports #0 to #3 by OUT instruction. 4-bit data on the addressed port is input into the accumulator by IN instruction. (Before IN instruction, the port to be addressed must be set up to "1" state (input) mode).)

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Table 1: PIN DESCRIPTION (Continued)

Symbol	Pin No.	Туре	Name & Function
• I/O Por	t (Contin	ued)	
R3 -R0,	40-37, (15-12)	1/0	Individual I/O: Each line from R14 to RO is indirectly addressed by the Y-register (Bit #). The addressed line
R7 -R4,	4- 1, (23-20)		is individually set/reset by SETR/RSTR instruction, and especially each line of R-Port #0 (R3-R0) is directly
R11-R8,	8- 5, (27-24)		set/reset by SETD/RSTD instruction. The addressed line is individually testable by TSTR instruction, and each
R14-R12	11- 9 (31,29, 28)		line of R-Port #2 (R11-R8) is directly testable in particular by TSTD instruction. (Before the TSTR and TSTD instructions, the line to be addressed must be set up to "1" (input mode).) Refer to Table 4 User mask options for available making option.

Note: Parenthesis number is applied to suffix -PF



DIFFERENCES BETWEEN MB8840 SERIES AND MB88400 SERIES

Table 2: DIFFERENCES BETWEEN MB8840 SERIES AND MB88400 SERIES

Device Item	MB8841	MB88401
ROM Size	· 2K x 8 bits	· 4K x 8 bits
RAM Size	· 128 x 4 bits	· 192 x 4 bits
Oscillator Type	· Crystal/Ceramic, RC-network OSC, or external clock drive	· Crystal/Ceramic OSC or external clock drive · RC-network OSC or external clock drive (Mask option)
Min. Instruction Execution Time	· 3.0µs use 4MHz with prescaler	· 2.86µs use 4.19MHz with prescaler
K-Port Input Level	· Standard threshold	 Standard threshold High-threshold (Mask option)
Watch-dog Timer Function	· No	· No · Yes (Mask option)
Instruction Number	70	75
Members	 MB8842M/-PSH, MB8846M MB8843M/-PSH, MB8847M MB8844M/-PSH, MB8848M part above. 	· MB88401-P/-PSH/-PF

INPUT/OUTPUT CIRCUITS

All input-only pins are internally pulled up, and all output-only and input/output pins except 0-, P-, and R-Ports have push-pull output buffer (standard pull-up). 0-, P-, and R-Ports can have push-pull (standard pull-up) or open-drain (standard or high-current) buffer using mask option.

Table 3: INPUT/OUTPUT CIRCUITS

Pin	Circuit	Note
RESET, TRQ, TC, SI, K-Port	• Input only pin About 500kΩ	IIL ≤ -60μA (VCC = 5.5V VIL = 0.4V)
SC/TO	• Input/Output pin About 500kΩ	IIL ≤ -1.8µA (VCC = 5.5V VIL = 0.4V
SO	• Output only pin	VOH ≥ 2.4V (VCC = 4.5V IOH = -200μA) VOL ≤ 0.4V (VCC = 4.5V IOL = 1.8mA)
O-Ports, P-Ports, R-Ports	• Standard pull-up	VOH ≥ 2.4V (VCC = 4.5V
	• Standard open-drain	VOL ≤ 0.4V (VCC = 4.5V IOL = 1.8mA) VOL ≤ 0.6V (VCC = 4.5V IOH = 3.6mA) With 10kΩ pullup resistor



Table 3: INPUT/OUTPUT CIRCUITS (Continued)

Pin	Circuit	Note
O-Ports, P-Ports, R-Ports	• High-current open-drain	VOL ≤ 0.4V (VCC = 4.5V

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USER MASK OPTIONS

The MB88400 series has the following mask options, which must be specified by the customer on the attached data release form when devices are ordered.

Table 4: USER MASK OPTIONS

Optional	Symbol	Option	Option	Note
Feature Clock	CLK	No	No.	f _C =0.5 MHz to 2 MHz
Prescaler	CLIK	NO	U	10-0.3 MAZ to 2 MAZ
		Yes	1	f _C =1 MHz to 4.19MHz
Oscillator	osc	Crystal/ceramic OSC	0	* When only external clock
Type		or external clock*		drive is used, we recommend RC-network oscillator.
		RC-network OSC or external clock*	1	We recommend no clock prescaler.
Output PLA Data	SPLA	4-bit parallel output	0	
		8-bit parallel output	1	
Output Port Type	PORT	Standard open-drain	2/L	Output port circuit option selected must be the same for
		Standard pull-up	3/M	all 0-, P-, and R-Ports.
		High-current open-drain	1/K	
K-Port Input Level	KIN	Standard threshold	0	
		High threshold	1	
Watch-dog Timer Function	WDR	No	. 0	
		Yes	1	



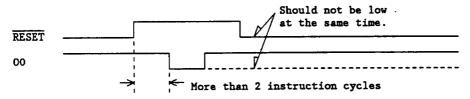
NOTES ON OPERATION

· Special Function of 00 Pin

The 00 pin has another function as a test terminal, in addition to its normal function 0-Port. If the 00 pin is forced low while the $\overline{\text{RESET}}$ pin is low, the MCU is placed in the test mode. Therefore, the 00 pin should not be forced low while the $\overline{\text{RESET}}$ pin is low (when all output ports are initialized).

Especially when the open-drain is selected for the output port option, the 00 pin should be externally pulled up because such open-drain outputs are subject to noise disturbance if left floating.

At least 2 instruction cycles are required to change 00 pin from high to low after releasing reset (\overline{RESET} : Low \rightarrow High)



• External Capacitors for Crystal Oscillation Fig. 7 gives an aim of an area where the on-chip oscillator has stable oscillator characteristics and short oscillation stabilization time when an average crystal resonator is used.

The external capacitor should be adjusted to individual crystal resonators when precise oscillation frequency is required. It is recommended to use crystal with a frequency higher than required oscillation frequency, together with the on-chip divided-by-two prescaler, because crystal resonators with lower oscillation frequency generally tends to have longer stabilization time and wider characteristics variation.

· Supply Voltage

Malfunction may occur even within the recommended operating supply voltage if the supply voltage changes rapidly. Therefore, the supply voltage should be regulated as well as possible. The following conditions are recommended for the power supply:

- (1) V_{CC} ripple (peak-to-peak value) at commercial frequency (50Hz to 60Hz): Less than 10% of typical V_{CC} value.
- (2) V_{CC} transient change rate (such as at switching of power supply): Less than 0.1V/ms.

INSTRUCTION SET DESCRIPTION

The MB88400 series instruction set includes 75 instructions, 82% of which are single-byte and single-cycle, 17% two-byte two-cycle, and 1% two byte three-cycle. The MB88400 series instruction set is exactly the same as the MB88500 series instruction set, and is divided into ten functional groups:

- Register-to-register transfer
- Register-to-memory transfer
- Constant transfer
- Arithmetic and logical operations
- Bit manipulation
- Control
- Input/Output
- Branch
- Flag manipulation
- Other

Tables 5 and 6 summarize the MB88400 series instruction set.

Table 5: INSTRUCTION SET SUMMARY

	Mnem	onic	Code	Fla	g/St	atus	Byte/	0
	+ope:	rand	(Hex.)	ZF	CF	ST	Cycle	Operation
Register-	TATH		05	•	•		1/1	TH+(AC)
to-	TATL		06	•	•	·	1/1	TL+(AC)
Register	TAS		07	•	•	•	1/1	SB+(AC)
Transfer	TAY		04	•	•		1/1	Y+(AC)
	TSA		17	Į.	•	•	1/1	AC+(SB)
	TTHA	ı	15	Î	•		1/1	AC+(TH)
	TTLA		16	t	•		1/1	AC+(TL)
	TYA		14	t	•		1/1	AC+(Y)
	XX		1B	1*1	•	•	1/1	(AC) ≉(X)
Register-	L		OD	1	•	•	1/1	$AC+\{M(X,Y)\}$
to-	LS		2B	1			1/1	$SB \leftarrow \{M(X,Y)\}$
Memory	ST		1D	•	•	•	1/1	$M(X,Y)\leftarrow(AC)$
Transfer	STDC		1A	•	•	†C	1/1	M(X,Y)+(AC), $Y+(Y)-1$
	STIC		0A		•	†C	1/1	M(X,Y)+(AC), $Y+(Y)+1$
	STS		2A	1	•	.	1/1	$M(X,Y)\leftarrow(SB)$
	X		OB	‡*1	•	•	1/1	$(AC) \neq \{M(X,Y)\}$
	XD	D	50-53*	1*1	•		1/1	$(AC) \neq \{M(0,D)\}; D=0 \text{ to } 3 (X=0, Y=D)$
	XYD	D	54-57 *	1*2	•		1/1	$(Y) \neq \{M(0,D)\}; D=4 \text{ to } 7 (X=0, Y=D)$
Constant	CLA		90	1	•	•	1/1	AC+0 (Included in LI instruction)
Transfer	LI	imm	90-9F*	ţ	•		1/1	AC←imm; imm=0 to 15
	LXI	imm	58-5F*	ţ			1/1	X3←0, X2 to X0←imm; imm=0 to 7
i	LXID	ŀ	3D90-	ŧ	•		2/2	X+imm; imm=0 to 15
			3D9F*					
	LRXA	imm	3D20-	٠	•		2/3	$X \leftarrow \{ROM([imm \mid X \mid Y])\}d, d=7-4$
			3D3F*					$AC \leftarrow \{ROM(\underbrace{imm \ X \ Y})\}d, d=3-0$
							}	imm=0 to 31
	LYI	imm	80-8F*	ŧ	•	.	1/1	Y ←imm; imm=0 to 15
Arithmetic	ADC		0E	ţ	ŧ	τC	1/1	$AC \leftarrow (AC) + \{M(X,Y)\} + (CF)$
& Logical	ΑI	imm	3D80-	:	t	†C	1/1	AC←(AC)+imm; imm=0 to 15
Operations			3D8F		İ			•
	AND		0F	t		ιz	1/1	$AC+(AC)\cap\{M(X,Y)\}$
[С		2E	1	ī	ĮΖ	1/1	$\{M(X,Y)\}-(AC)$
	CI	imm	BO-BF*	ţ	î	ŧΖ	1/1	imm-(AC); imm=0 to 15
	CYI	imm	AO-AF*	.		ţΖ	1/1	imm-(Y); imm=0 to 15
							1-	59

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Table 5: INSTRUCTION SET SUMMARY (Continued)

	Mnemonic	Code	Fla	g/St	atus	Byte/	0
	+Operand	(Hex.)	ZF	CF	ST	Cycle	
Arithmetic	DAA	10		1	ţC	1/1	AC+(AC)+6 if (AC)>9 or (CF)=1
& Logical	DAS	11		t	†C	1/1	AC+(AC)+10 if $(AC)>9$ or $(CF)=1$
Operation	DCA	3D8F	‡	t	†C	1/1	AC+(AC)+15 (Included in AI instruc-
-,	DCM	19	ı		‡C	1/1	$M(X,Y)+\{M(X,Y)\}-1$ tion)
	DCY	18			1C	1/1	Y+(Y)-1
	EOR	2F	1		ΙZ	1/1	$AC+\{M(X,Y)\}\Theta(AC)$
	ICA	3D81	Į.	1	ŤС	1/1	AC+(AC)+1 (Included in AI instruc-
	ICM	09	1		fС	1/1	$M(X,Y)+\{M(X,Y)\}+1$ tion)
	ICX	3DAC	•	١.	ŤС	2/2	X← (X)+1
	ICY	08	1	٠	†C	1/1	Y←(Y)+1
	NEG	2D	•	•	ĮΖ	1/1	AC+(AC)+1
	OR	1F	‡	•	ĮΖ	1/1	$AC+\{M(X,Y)\}\cup(AC)$
	ROL	oc	ī	1	ţĊ	1/1	(CF) A.C.
	ROR	1C	t	:	τC	1/1	A.C. CE
	SBC	1E	ī	1	1C	1/1	$AC+\{M(X,Y)\}-(AC)-(CF)$
Bit	RBIT bp	34-37*		· ·	· •	1/1	{M(X,Y)}bp+0; bp=0 to 3
Manipula-	SBIT bp	30-33*				1/1	{M(X,Y)}bp+1; bp=0 to 3
tion	RBA bp	3DA4			_	2/2	(AC)bp+0 ; bp=0 to 3
*****	1.21. JP	3DA7 *		1		-, -	, , , , , , , , , , , , , , , , , , ,
	SBA bp	3DA0				2/2	(AC)bp+1 ; bp=0 to 3
	J.JF	3DA3 *				-,-	(/-F = , .
	TBA bp	4C-4F*		· ·	ŧΖ	1/1	(AC)bp-1 ; bp=0 to 3
	TBIT bp		1	١.	ΙZ	1/1	$\{M(X,Y)\}$ bp-1; bp=0 to 3
Control		3E00-	•	1	•	2/2	Enable the internal resources by
		3EFF*		1		·	the operand byte (2nd byte); *3
	DIS imm	3F00-	١.	١.		2/2	Disable the internal resources by
]	3FFF*	ł	l			the operand byte (2nd byte); *3
Input/	IN	13	1		•	1/1	AC+(R)Y ; Y=0 to 3 (Port #)
Output					l		AC+(REG)Y; Y=9 to 15
•	INK	12	t			1/1	AC+(K)
ļ	OUT	03	•	•	•	1/1	(R)Y←(AC); Y=0 to 3 (Port #)
ŀ			ĺ		1	i	(REG)Y+(R);Y=9 to 15
	OUTO	01	١.			1/1	If CF=0 03-00+(AC)
		I		ĺ		ļ	If CF=1 07-04+(AC)
	OUTP	02			<u> </u>	1/1	P+(AC)
	RSTD d	44-47*	•	•	•	1/1	(R)d+0; d=0 to 3 (Bit # of Port #0)
	RSTR	22	١٠		٠.	1/1	(R)Y+0; Y=0 to 15 (Bit #)
	SETD d	40-43*	1 •	·	١٠	1/1	(R)d+1; d=0 to 3 (Bit # of Port #0)
	SETR	20	Ŀ	<u> : </u>	<u> : _</u>	1/1	(R)Y+1; Y=0 to 15 (Bit #)
	TSTD d	48-4B*	1 · _		ĮΖ	1/1	(R)d-1; d=8 to 11 (Bit #)
	TSTR	24	<u> </u>	<u> · </u>	↓Z	1/1	(R)Y-1; Y=0 to 15 (Bit #)
Branch	CALL add		1 .			2/2	If ST=1, Subroutine Call for addr;
		6FFF*	1				addr=0 to 4095.
	1	l	<u> </u>	<u> </u>		L	ST=0, Not Subroutine Call.

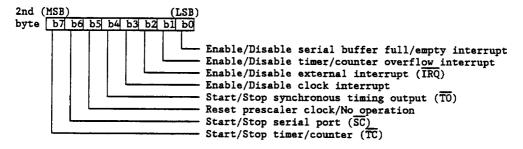


Table 5: INSTRUCTION SET SUMMARY (Continued)

	Mnemonic	Code	Fla	g/St	atus	Byte/	2
	+Operand	(Hex.)	ZF	CF	ST	Cycle	Operation
Branch	JMP addr	CO-FF*	•	•	•	1/1	If ST=1, Branch to addr; addr=0 to 63
				ŀ			ST=0, No Branch.
	JPXY addr	3D00- 3D1F*	•	١.	•	2/2	Branch always to addr on page #n;
	JPL addr	7000-				2/2	If ST=1, Branch to addr;
		7FFF*					addr=0 to 4095.
							ST=0, No Branch.
]	RTI	3C	٠	•	•	1/1	Return From Interrupt Routine
	RTS	2C	٠	•	·	1/1	Return From Subroutine
Flag	RSTC	23	•	+	•	1/1	CF+0
Manipula-	SETC	21	•	1	•	1/1	CF+1
tion	TSTC	28	•	•	†CE		(CF)-1
	TSTI	25	•	•	ΙIF	1/1	(IF)-1, (If <u>IRQ</u> =L, IF=1)
	TSTS	27	•		↓SF	1/1	(SF)-1, SF+0
	TSTV	26	•		1VE	1/1	(VF)-1, VF+0
	TSTZ	29	•	•	↓ZF	1/1	(ZF)-1
Other	NOP	00	•		•	1/1	No Operation

Notes:

- *1: ZF is set or reset depending on contents of AC after instruction execution.
- *2: ZF is set or reset depending on contents of Y after instruction execution.
- *3: Each bit of the operand (the second byte) functions as follows:





Symbols and Abreviations

Meaning

Symbols

ZF

Zero flag

```
Is transferred to
 *
                  Is exchanged with
                  Arithmetic plus
                  Arithmetic minus
 ⊕
∩
                  Logical exclusive or
                  Logical OR
 Ų
                  Logical AND
      (Overline)
                  Negation
                  Contents of parenthesis
Set to "1" always
( )
                  Set to "0" always
 ‡
                  Affected (set or reset) by operation results
                  Set to "0" due to carry (not carry flag)
 ↓C
                  Set to "0" due to carry flag
 ↓CF
                  Set to "0" due to interrupt flag
 ↓IF
                  Set to "0" due to serial buffer full/empty flag
 ↓SF
                  Set to "0" due to timer/counter overflow flag
  ↓VF
                  Set to "0" due to zero (not zero flag)
 ψZ
                  Set to "0" due to zero flag
  ↓ZF
                  Not affected
                  Meaning
Abbreviation
                  Accumulator
 AC
  addr
                  Jump address
                  Bit pointer (that is part of the instruction code)
 bр
  C
                  Carry
  CF
                  Carry flag
                  Direct line number (that is part of the instruction code)
  d
  IF
                  Interrupt flag
                  Immediate data
  imm
  IRQ
                  Interrupt request
                  K-Port (K3 to K0)
  K
  LSB
                  Least significant bit
                  Data memory (RAM) location indirectly addressed by data pointer
 M(X,Y)
                  (X- and Y-registers)
                  Data memory (RAM) location directly addressed by "D" bits in the
  M(0,D)
                  instruction code, in page #0 (X=0)
  MSB
                  Most significant bit
  0
                  0-Port (07-00)
  PLA
                  Programmable Logic Array
                  R-Port (#0: R3-R0, #1: R7-R4, #2: R11-R8, #3: R14-R12)
                  ① R-Port #n specified by Y-register (Y=0 to 3)
  (R)Y; Y=n
                  ② R-Port bit n specified by Y-register (Y=0 to 14)
                  R-Port bit n specified by "d" bits in the instruction code
  (R)d; d=n
                  Serial buffer register
  SB
  SF
                  Serial buffer full/empty flag
  ST
                  Status flag
  TH
                  Timer/counter high byte
                  Timer/counter low byte
  TL
                  Timer/counter overflow flag
  VF
                  X-register (that indicates page # in data memory RAM)
  X
                  The n-th bit X-register
  Χn
  Y
                  Y-register
                                            1-62
  Z
                  Zero
```

MB88400 SERIES



Table 6: INSTRUCTION CODES SUMMARY

	,															
H	0	1	2	3	4	5	6	7	8	9	A	В	С	D	E	F
0	NOP	ouro	OUTP	OUT	TAY	ТАТН	TATL	TAS	ICY	ICM	STIC	х	ROL	L	ADC	AND
1	DAA	DAS	INK	IN	TYA	TTHA	TTLA	TSA	DCY	DCM	STDC	xx	ROR	ST	SBC	OR
2	SETR	SETC	RSTR	RSTC	TSTR	TSTI	TSTV	TSTS	TSTC	TSTZ	STS	LS	RTS	NEG	С	EOR
3			BIT bp				BIT bp		TBIT bp				RTI	* EXT	EN imm	DIS
4			ETD			R	STD d			T	STD d			T.	BA	
5			XID D				YD D						XI mm		-	
6	CALL addr															
7								J	PL ddr							
8								Ľ	YI non							
9	(CLA)							L								
A									YI							
В								C: ir	I. non					•		
С					-											
D	JMP															
E	addr															
F																



Table 6: INSTRUCTION CODES SUMMARY (Continued)
Extended instruction

3DL 3DH	0	1	2	3	4	5	6	7	8	9	A	В	С	D	E	F
0		JPXY addr														
1	Į.			,												
2		LRXA imm														
3	**************************************															
4								NOT	USE							
5																
6								NOT	USE							
7																
8	_	(ICA)	 					<i>I</i>	I mm							(DCA)
9									(ID				,			
A		SI br	BA			I l	RBA Op			NO7	USE		ICX	1	U TOM	SE
В			. ==				==	NO:	USE							
С								NO	r USE							
D																
Е								NO'	r use							,
F											-		·- <u>-</u>			

Note: : 3 byte/3 cycle instruction	1-64
------------------------------------	------

The MB88400 series consists of the MB88401. The MB88408U are available as piggyback EPROM evaluation devices. Refer to Table 7.

Table 7: MB88500 SERIES PRODUCT LINE-UP & DEVELOPMENT TOOLS

	MB88401-P/-PSH/-PF	MB88408U-C-001E/-002E/-003E
ROM Size	4K x 8 bits	4K x 8 bits
	(On-chip mask ROM)	(External ERPOM)
RAM Size	192 x 4 bits	192 x 4 bits
(Directly addressed	(0-7)	(0-7)
locations)		
I/O Port:	Total 36 lines	Total 36 lines
-Input-only Port	4	4
-Output-only Port	12	12
-I/O Port	15	15
-Control Port	5 (Including serial I/O)	5 (Including serial I/O)
Output Port Type	· Standard pull-up	· High-current open-drain
	· Standard open-drain	•
•	· High-current open-drain	
	(Mask option)	
K-Port Input Level	· Standard threshold	· Standard threshold
	· High threshold	
0		
Output PLA Pattern	33 patterns	
	· Dual 4-bit parallel ouptut	
	· 8-bit PLA output	(-001E)
	(32 patterns)	· 8-bit PLA output
Stack Depth	0 11-	(-002E/-003E)
(Nesting Level)	8 levels	8 levels
Timer/Counter:	Yes (Auto loading)	Yes (Auto loading)
-Buffer Size	8 bits	8 bits
-Clock Source	Internal/External	Internal/External
Serial I/O:	Yes	Yes
-Buffer Size	4 bits	4 bits
-Clock Source	Internal/External	Internal/External
-Output Latch	Yes	Yes
Clock Generator:	Yes	Yes
-Oscillator Type	· Crystal/External	· Crystal/RC-network/
obolilator Type	· RC-network/External	External
	(Mask option)	BACCINAL
-Clock Frequency	0.5MHz-2MHz	0.5MHz-2MHz
(With prescaler)	(1MHz-4.19MHz)	(1MHz-4.19MHz)
Clock Prescaler	Yes/No	Yes/No
(Divid-by-two)	(Mask option)	(Selected by external pin)
\	((2020000 b) Gyreriai bill)
Interrupt Function	Yes	Yes
-Nesting Level	Single level	Single level
-Interrupt Sources	4 Sources	4 Sources
Watch Dog Timer	· No	· No
Function	· Yes	- · -
	(Mask option)	
·	(-Jack operon)	

1-65



Table 7: MB88500 SERIES PRODUCT LINE-UP & DEVELOPMENT TOOLS

	MB88401-P/-PSH/-PF	MB88408U-C-00XE		
Number of	75	75		
Instructions				
Instruction	1/1, 2/2, or 2/3	1/1, 2/2, or 2/3		
Length/Cycle				
Min. Instruction	2.86 µs at 4.19 MHz	2.86 µs at 4.19 MHz		
Execution Time	(With prescaler)	(With prescaler)		
Power Supply:	Single +5V	Single +5V		
-Active	_			
vcc	· 4.5V to 5.5V	· 4.5V to 5.5V		
VM	· 4.5V to 5.5V	· 4.5V to 5.5V		
-Standby				
VM	- 3.0V to 5.5V	· 3.5V to 6.0V		
Operating				
Temperature range:		-30°C to +70°C		
Process	NMOS	NMOS		
Package	· DIP-42P	· MDIP-42P		
	· SH-DIP-42P			
	· QFP-48P			
Development Tools:				
-Hardware	MB2115-01 : CRT unit (Come	•		
	MB2115-02 : Monitor board	• •		
	MB2115-04 : EPROM writer ((Common)		
	MB2115-13 : DUE board	TTT 1000		
-Software	SM05212-A010: Intellec serie			
1	SM07415-A012: CP/M-86 cross-			
	SMXXXXX-XXXX: PC-DOS cross-			
	SM07415-G022: CP/M-86 host			
<u></u>	SMXXXXX-XXXX: PC-DOS host en	nuiator		

ELECTRICAL CHARACTERISTICS

• ABSOLUTE MAXIMUM RATINGS †

Parameter	Symbol		Rating		17-24	D1
rarameter	Зушьот	Min.	Тур.	Max.	Unit	Remarks
Supply Voltage	vcc	V _{SS} -0.3		V _{SS} +7.0	V	
	V _M	V _{SS} -0.3		V _{SS} +7.0	V	
	Vss		0		V	
Input Voltage	v _{IN}	V _{SS} -0.3		V _{SS} +7.0	V	
Output Voltage	Vout	V _{SS} -0.3		V _{SS} +7.0	V	·
Power Dissipation	PD			1000	mW	
Operating Ambient	TA	-30		+70	°C	
Storage Temperature	TSTG	-55		+150	°C	

[†] Permanent device damage may occur if the above ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

• RECOMMENDED OPERATING CONDITIONS

Parameter	Cbal		Value		Unit	B
rarameter	Symbol	Min.	Тур.	Max.	Unit	Remarks
Supply Voltage	v _{CC}	4.5	5.0	5.5	V	Active operation range
_	V _M	4.5	5.0	5.5	V	Active operation range
		3.0		5.5	V	Standby operation range
	V _{SS}		0	-	V	
Input High Voltage	VIH	2.0		V _{CC}	V	SI, R-Port, K-Port(Standard threshold)
•		2.4		v _{CC}	V	K-Port (High threshold)
	VIHS	4.0		v _{CC}		EX, SC/TO, IRQ, TC, RESET
Input Low Voltage	VIL	-0.3		0.8	V	SI, R-Port, K-Port(Standard threshold)
		-0.3		1.2	V	K-Port (High threshold)
	VILS	-0.3		0.8		EX, SC/TO, IRQ, TC, RESET
Operating Ambient Temperature	TA	-30		+70	°C	

• DC CHARACTERISTICS

(Recommended operating conditions unless otherwise noted.)

3	C1-1	Din /Dont	Condition	V	alue		Unit
Parameter	эйшрот	Pin/Port		Min.	Тур.	Max.	OHIG
Output High Voltage	v _{OH}	O-, P-, R-Ports (Standard pull- up), SC/TO, SO	V _{CC} =4.5V I _{OH} =-200μA	2.4			V
	v _{OHC}	O-, P-, R-Ports (Standard pull- up), SC/TO, SO	V _{CC} =4.5V I _{OH} =-10μA	4.0			٧
Output Low Voltage	V _{OL}	$\overline{SC}/\overline{TO}$, so	V _{CC} =4.5V I _{OL} =1.8mA			0.4	٧
		O-, P-, R-Ports (All output options)	V _{CC} =4.5V I _{OL} =1.8mA			0.4	v
			V _{CC} =4.5V I _{OL} =3.6mA			0.6	v
		O-, P-, R-Ports (High-current open-drain)	V _{CC} =4.5V I _{OL} =20mA			2.0	V
Open-Drain Output Leakage Current	ILEAK	O-, P-, R-Ports (Standard/High- current open- drain)	V _{CC} =5.5V V _{OH} =5.5V (Off state)			40	μА
Input Leakage Current	IIL	R-Port(Standard pull-up), SC/TO	V _{CC} =5.5V V _{IL} =0.4V			-1.8	m.A
		EX, K-Port, SI, RESET, IRQ, TC	V _{CC} =5.5V V _{IL} =0.4V			-60	μА
Supply Current	ICC	VCC	V _{CC} =5.0V		70		mA
	IM	V _M	V _M =3.0V		5		μА

• AC CHARACTERISTICS

CLOCK TIMING

(Recommended operating conditions unless otherwise noted.)

Parameter	Symbol	Pin	Condition		lue Max.	Unit	Remarks	
Clock Frequency	f _C	EX,	Crystal/ceramic or RC-network	0.5	2		Without prescaler	
			OSC or external clock drive: Figs. 4 and 5	1	4*	MHz	With prescaler * Can use 4.19MHz crystal	
Clock Cycle Time	t _{cyc}	EX, X	Figs. 4 and 5	0.5	2	μs	-	
Input Clock Pulse Width	Pwch,	EX	External clock drive(with X	225		ns	Without prescaler	
			open): Figs. 4 and 5	100			With prescaler	
Input Clock Rise/Fall Time	t _{cr} , t _{cf}	EX	External clock drive(with X open): Figs. 4 and 5	5	200	ns		

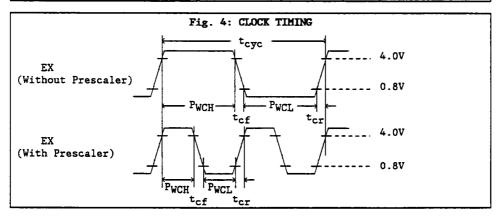
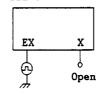


Fig. 5: CLOCK CIRCUIT CONFIGURATIONS

- (1) Crystal/Ceramic Oscillator
 - EX X
- (2) RC-Network Oscillator*



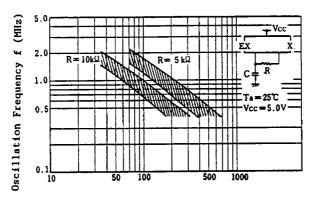
(3) External Clock Drive



- * When the RC-network oscillator is used, the following conditions must be met: 1) The prescaler is not used.
 - 2) V_{CC}=5V±10%

 - 3) $T_A = -30^{\circ}C$ to +75°C 4) f_C does not exceed 2 MHz (Max. clock frequency is about 1.6 MHz at V_{CC}=5V and T_A=25°C.)





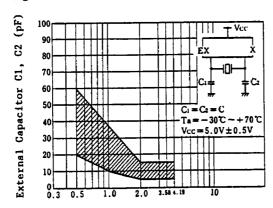
External Capacitor C (pF)

Note

When the RC-network oscillator is used, the following conditions must be met:

- 1) The prescaler is not used. 2) V_{CC}=5V±10%
- 3) $T_A = -30^{\circ}C$ to $+70^{\circ}C$
- 4) fc does not exceed 1.6 MHz.





Notes:

Oscillation Frequency f (MHz)

- 1) The cross-hatched portion is an area where the on-chip oscillator has stable characteristics and short stabilization time when a typical crystal resonator is used. This chart gives an target value of the external capacitor to realize the desired frequency. When an exact frequency is needed, capacitor value should be determined, adjusted to individual crystal resonator characteristics.
- 2) Generally speaking, crystal resonators with lower oscillation frequency tend to have longer stabilization time and wider characteristic variations which affect on-chip oscillator characteristics. So, we recommend a high-frequency crystal resonator with on-chip 1/2 prescaler.

FUJITSU

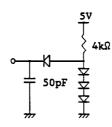
OUTPUT TIMING

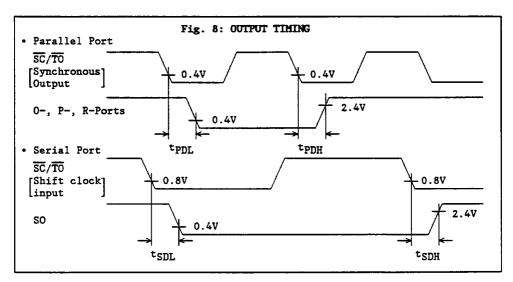
(Recommended operating conditions unless otherwise noted.)

Parameter	Symbol	Pin/Port	Condi-	Va	lue	Unit
rarameter	ЗУШООТ	PIM/POPC	tions	Min.	Max.	Onit
O-,P-,R-Ports Delay Time	tPDH	O-Port, P-Port,	Fig. 8		1000	ns
-	tPDL	R-Port	1		350	
Serial Port Delay Time	tSDH	SO	Fig. 8		600	ns
-	tSDL				600	

Notes:

- 1. A $10k\Omega$ pull-up is required when open-drain output is used.
- 2. All the output loading values are 50pF + 1TTL. See figure below.



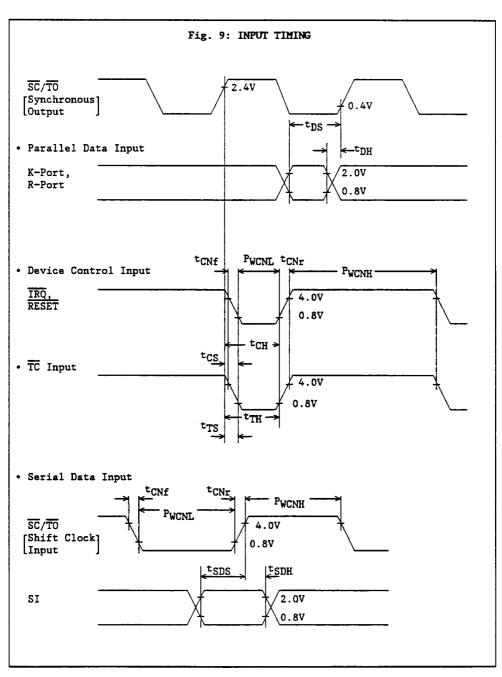




INPUT TIMING(MB88501/A)

(Recommended operating conditions unless otherwise noted.)

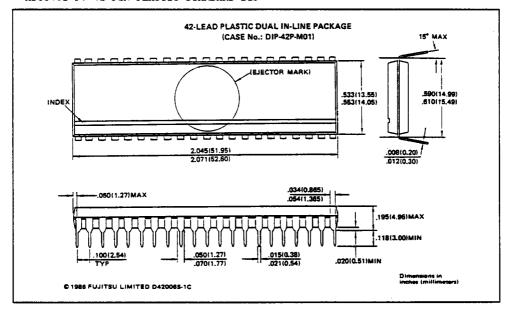
D	C	Dia /Dant	Conditions	Val	ue	Unit
Parameter	Symbol	Pin/Port	Conditions	Min.	Max.	Unit
Input Data Setup Time	t _{DS}	K-Port, R-Port	Fig. 9	t _{cyc} +1000	•	ns
Input Data	tou	K-FOI C			t _{cyc} -50	113
Hold Time	tDH				cyc 50	
SI Input	tsps	SI	Fig. 9	600		
Setup Time	פתפ					ns
SI Input	tSDH			600		
Hold Time	DDII					
Device Control	tcs		Fig. 9		2t _{cyc} -200	
Setup Time		RESET				ns
(Synchronous					2t _{cyc} -200	
mode)		IRQ				
Device Control	^t CH	l ——	Fig. 9	8t _{cyc} +50		
Hold Time		RESET				ns
(Synchronous				2tcyc+50		
mode)		IRQ			200	
Timing Input	^t TS	TC	Fig. 9		2t _{cyc} -200	
Setup Time		10				ns
(synchronous mode)				}		
Timing Input	+		Fig. 9	2t _{cyc} +50		
Hold Time	^t TH	TC	118.	20cyc 30		ns
(Synchronous		10				
mode)						ŀ
Control Signal	PWCNL		Fig. 9	6t _{cyc} +250		
Low Level Time	WOLLD	SC/TO		0,0		
(Asynchronous			1	6t _{cyc} +250		ns
mode)		IRQ, TC				
			}	12t _{cyc} +250		
		RESET				
Control Signal	PWCNH		Fig. 9	12t _{cyc} +250		
High Level Time		SC/TO		4		1
(Asynchronous				6t _{cyc} +250		ns
mode)		RESET, TC,	1			
Common Ciarril	+	IRQ START,		 	l	l
Control Signal Rise and Fall	tCNr,	SC/TO, IRQ	Fig. 9	Should be 1	ess than 20	Ons
Time	tCNf	RESET, TC	1.18.	guoura pe i	.cos cuem ZC	, ons
TTME		RESEI, IL		<u> </u>		



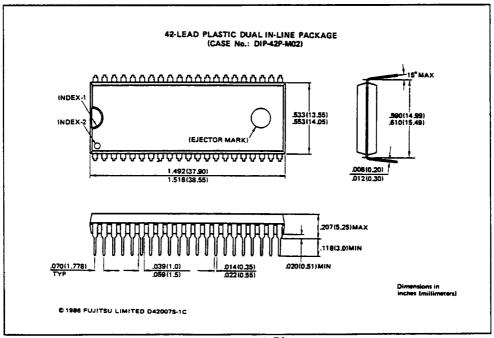


PACKAGE DIMENSIONS

• MB88401-P: 42-PIN PLASTIC STANDARD DIP

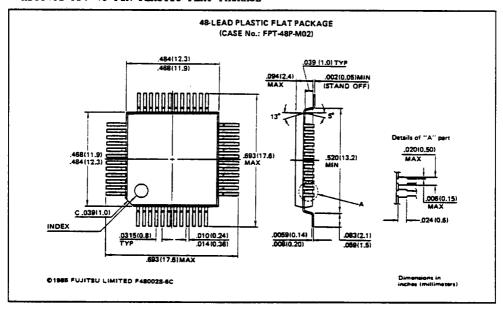


• MB88401-PSH: 42-PIN PLASTIC SHRINK DIP



PACKAGE DIMENSIONS (Continues)

• MB88401-PF: 48-PIN PLASTIC FLAT PACKAGE



• MB88408U-C: 42-PIN CERAMIC MODULE

